

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6130048

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KEN MIYAGI	03/12/2020
TAKAHIRO DAZAI	03/12/2020
TOSHIFUMI SATOH	03/11/2020
TAKUYA ISONO	03/11/2020

RECEIVING PARTY DATA

Name:	TOKYO OHKA KOGYO CO., LTD.
Street Address:	150, NAKAMARUKO, NAKAHARA-KU
Internal Address:	KANAGAWA
City:	KAWASAKI-SHI
State/Country:	JAPAN
Postal Code:	211-0012
Name:	NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY
Street Address:	KITA 8-JYO NISHI 5-CHOME
Internal Address:	HOKKAIDO
City:	KITA-KU, SAPPORO-SHI
State/Country:	JAPAN
Postal Code:	060-0808

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16878314

CORRESPONDENCE DATA

Fax Number: (949)760-9502

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ATTORNEY DOCKET NUMBER:	SHIGA7.523AUS
NAME OF SUBMITTER:	NEIL S BARTFELD
SIGNATURE:	/Neil S. Bartfeld/
DATE SIGNED:	05/29/2020
Total Attachments: 4 source=2020-05-19 Combined Declaration Assignmnet - SHIGA7.523AUS#page1.tif source=2020-05-19 Combined Declaration Assignmnet - SHIGA7.523AUS#page2.tif source=2020-05-19 Combined Declaration Assignmnet - SHIGA7.523AUS#page3.tif source=2020-05-19 Combined Declaration Assignmnet - SHIGA7.523AUS#page4.tif	

**COMBINED DECLARATION & ASSIGNMENT
UNDER 37 CFR 1.63(e)**

Attorney Reference No.: _____

Page 1 of 2

Title: RESIN COMPOSITION FOR FORMING PHASE-SEPARATED STRUCTURE, METHOD FOR PRODUCING
STRUCTURE INCLUDING PHASE-SEPARATED STRUCTURE, AND BLOCK COPOLYMER

Legal Names of All Inventors: Ken MIYAGI; Takahiro DAZAI; Toshifumi SATOH and Takuya ISONO

Please Direct All Correspondence to Customer Number **20995**

Declaration of Inventors

As an individual executing this Declaration, I hereby declare that:

This Declaration is directed to the invention identified above that: (check one)

☒ Is attached, where "attached" means filed concurrently with.

☐ Was filed on _____ as U.S. Application No. _____

☐ Was filed on _____ as International Application No. _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Assignment from Inventors

WHEREAS, the Inventor(s) identified above (Individual(s) hereinafter "ASSIGNOR") invented certain new and useful improvements, technology, inventions, developments, ideas or discoveries while under an obligation to assign related to the title identified above (collectively hereinafter referred to as the "Work") for which the application identified above has been or will be filed (hereinafter the "Application").

AND WHEREAS, (1) TOKYO OHKA KOGYO CO., LTD. and (2) NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY with its principal place of business at (1) 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan and (2) Kita 8-ijo Nishi 5-chome, Kita-ku, Sapporo-shi, Hokkaido 060-0808 Japan (hereinafter the "ASSIGNEE"), desires to acquire the entire right, title, and interest in and to the Application and the Work.

NOW, THEREFORE, for good and valuable consideration of which receipt is hereby acknowledged, ASSIGNOR hereby acknowledges that ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in the Application and the Work, including all patent properties filed or issued upon the Application and the Work; where "Patent Properties" include, but are not limited to:

all provisional applications relating thereto (including but not limited to U.S. Provisional Application No(s). _____ filed _____ (respectively if plural applications));

all nonprovisional applications claiming priority to aforementioned provisional(s) and/or the present Application, including, all divisions, continuations, continuations-in-part, and reissues, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof; and

all rights of priority under International Conventions and any related Letters Patent which may hereafter be granted or filed in any country or countries foreign to the United States, all extensions, renewals and reissues thereof.

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ASSIGNOR hereby acknowledges the ASSIGNEE as the Applicant for all aforementioned patent properties, and authorizes and requests the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all related Letters Patent to the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance.

AND ASSIGNOR DOES HEREBY covenant and agree that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting the Work, and testify in any legal proceeding, assist in the preparation of any other Patent Property relating to the Application and the Work or any Improvements made thereto, sign/execute all lawful papers, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for the Work in all countries.

1. Legal Name of Inventor: Ken MIYAGI

Signature of Inventor: Ken Miyagi Date: March 12, 2020

2. Legal Name of Inventor: Takahiro DAZAI

Signature of Inventor: Takahiro Dazai Date: March 12, 2020

3. Legal Name of Inventor: Toshifumi SATOH

Signature of Inventor: _____ Date: _____

4. Legal Name of Inventor: Takuya ISONO

Signature of Inventor: _____ Date: _____

5. Legal Name of Inventor: _____

Signature of Inventor: _____ Date: _____

6. Legal Name of Inventor: _____

Signature of Inventor: _____ Date: _____

P2018-172-6501
OSP-89592

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1. Legal Name of Inventor: Ken MIYAGI

Signature of Inventor: _____ Date: _____

2. Legal Name of Inventor: Takahiro DAZAI

Signature of Inventor: _____ Date: _____

3. Legal Name of Inventor: Toshifumi SATOH

Signature of Inventor: Toshifumi Satoh Date: March 11, 2020

4. Legal Name of Inventor: Takuya ISONO

Signature of Inventor: Takuya Isono Date: March 11, 2020

5. Legal Name of Inventor: _____

Signature of Inventor: _____ Date: _____

6. Legal Name of Inventor: _____

Signature of Inventor: _____ Date: _____